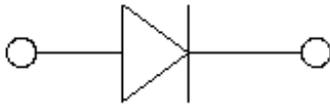


## Schottky Barrier Rectifier



### Features

- Moisture sensitivity level 1
- Reverse voltage: 20V/30V/40V
- Average forward current : 1A

### Application

- High frequency and low voltage rectifier

### Mechanical data

- **Package:** SOD-323
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102

### ■ Maximum Ratings (T<sub>a</sub>=25°C Unless otherwise specified)

Parameter	Symbol	Unit	Value	
Device marking code			B5817WS	SJ
			B5818WS	SK
			B5819WS	SL
Repetitive peak reverse voltage	V <sub>RRM</sub>	V	B5817WS	20
			B5818WS	30
			B5819WS	40
Forward current	I <sub>F</sub>	A	1	
Non-repetitive surge peak forward current @ t=8.3ms half-sine wave	I <sub>FSM</sub>	A	10	
Non-repetitive surge peak forward current @ t=1ms square wave			15	
Repetitive Peak Forward Current@ t <sub>p</sub> =1ms, δ=0.25	I <sub>FRM</sub>	A	12	
Power dissipation	P <sub>D</sub>	mW	200	
Junction temperature	T <sub>J</sub>	°C	-65 to +125	
Storage temperature	T <sub>STG</sub>	°C	-65 to +150	



## B5817WS THRU B5819WS

### ■ Electrical Characteristics (T<sub>a</sub>=25°C Unless otherwise specified)

Parameter	Symbol	Unit	Conditions		Min	Typ	Max
Reverse voltage	V <sub>R</sub>	V	B5817WS	I <sub>R</sub> =1mA	20		
			B5818WS		30		
			B5819WS		40		
Forward voltage	V <sub>F1</sub>	V	B5817WS	I <sub>F</sub> =1A			0.45
			B5818WS				0.55
			B5819WS				0.60
	V <sub>F2</sub>	V	B5817WS	I <sub>F</sub> =3A			0.75
			B5818WS				0.875
			B5819WS				0.90
Reverse leakage current	I <sub>R</sub>	uA	B5817WS	V <sub>R</sub> =20V			200
			B5818WS	V <sub>R</sub> =30V			40
			B5819WS	V <sub>R</sub> =40V			40
Junction capacitance	C <sub>j</sub>	pF	V <sub>R</sub> =4V, f =1MHZ				120



# B5817WS THRU B5819WS

## ■ Thermal Characteristics

Parameter	Symbol	Unit	Value
Thermal resistance, junction-to-ambient	$R_{\theta J-A}^{(1)}$	$^{\circ}C/W$	500
Thermal resistance, junction-to-case	$R_{\theta J-C}^{(1)}$	$^{\circ}C/W$	400

Note:

(1) Thermal resistance from junction to ambient and from junction to case mounted on P.C.B. with 8mm\*9mm copper pad areas

## ■ Characteristics

### B5817WS

Fig 1:  $P_D$ - $T_a$  Curve

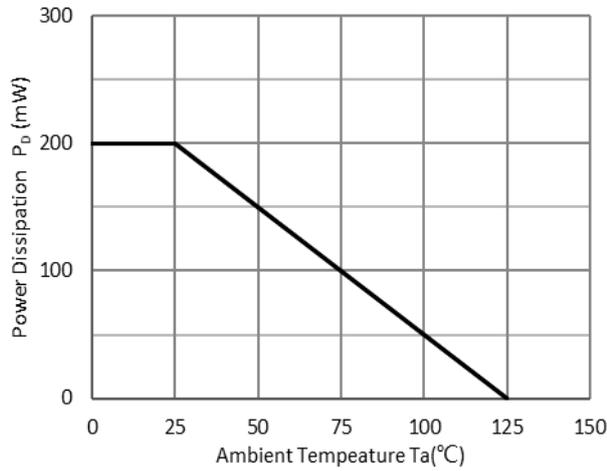


Fig 2: Capacitance Capability

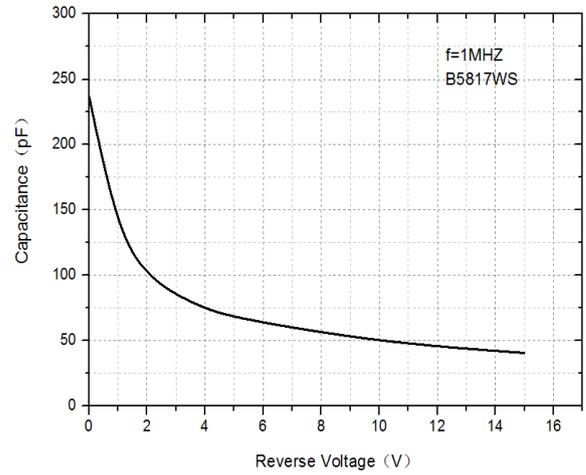


Fig 3: Typical Forward Characteristics

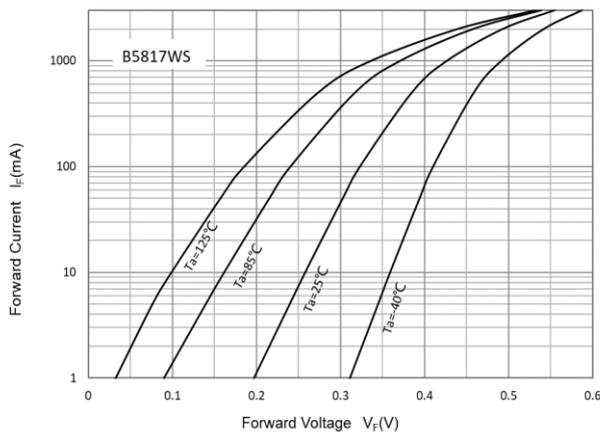
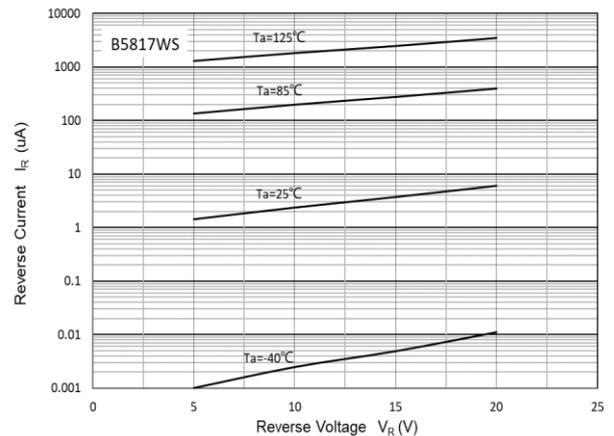


Fig 4: Typical Reverse Characteristics

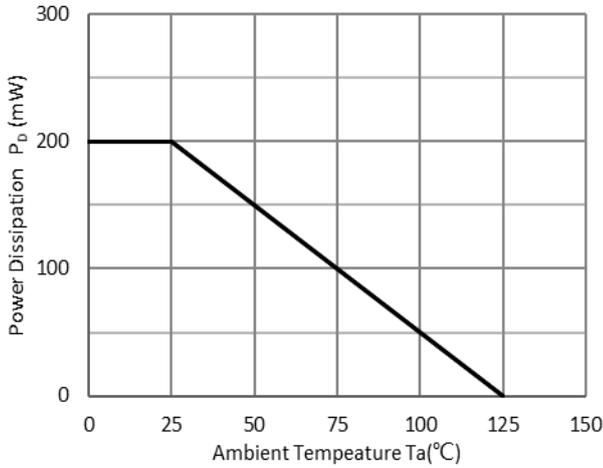




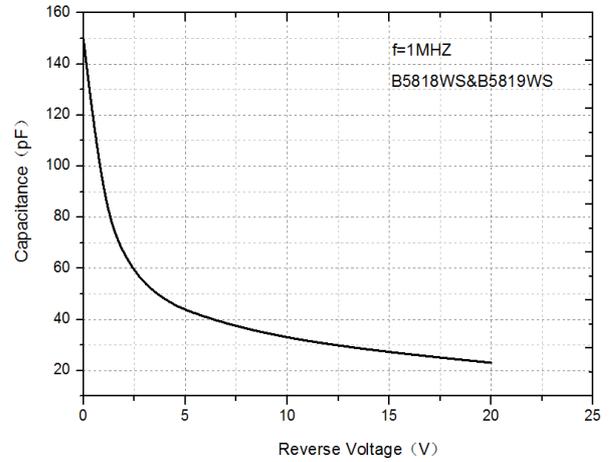
# B5817WS THRU B5819WS

## B5818WS & B5819WS

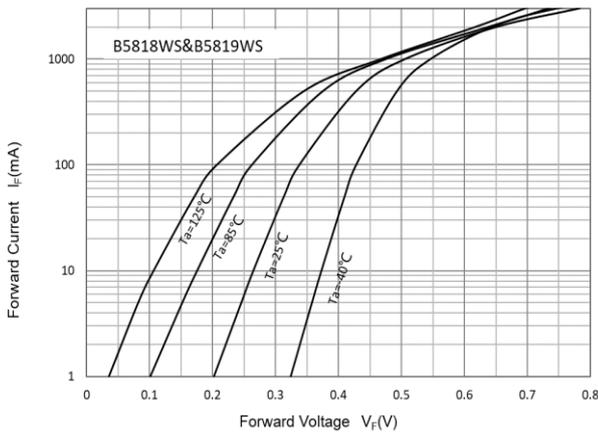
**Fig 1: P<sub>D</sub>-T<sub>a</sub> Curve**



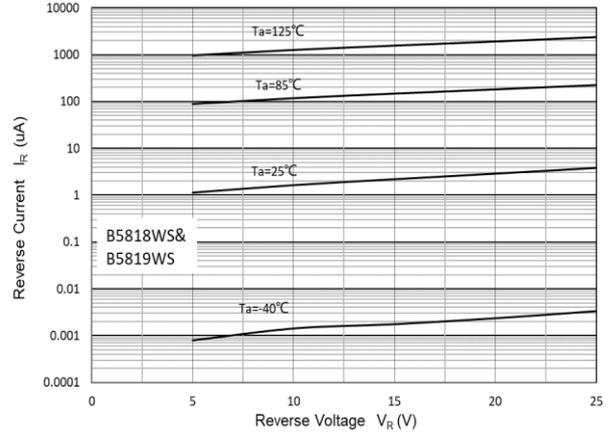
**Fig 2: Capacitance Capability**



**Fig 3: Typical Forward Characteristics**



**Fig 4: Typical Reverse Characteristics**



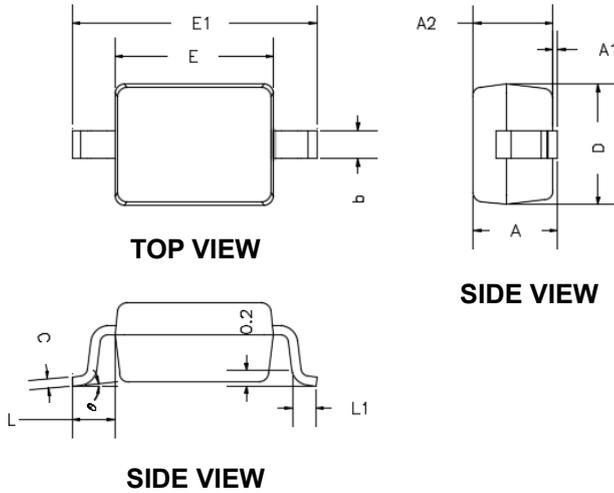
### ■ Ordering Information

Preferred P/N	Packing code	Unit weight(g)	Minimum package(pcs)	Inner box quantity(pcs)	Outer carton quantity(pcs)	Delivery mode
B5817WS THRU B5819WS	F2	Approximate 0.0048	3000	30000	120000	7" reel
B5817WS THRU B5819WS	F3	Approximate 0.0048	10000	/	210000	13" reel



# B5817WS THRU B5819WS

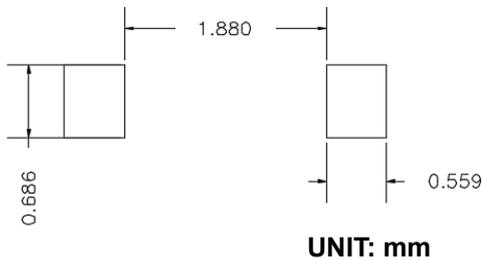
## ■ Outline Dimensions



DIMENSIONS				
DIM	INCHES		MM	
	MIN	MAX	MIN	MAX
A	---	0.0393	---	1.0000
A1	0.0000	0.0039	0.0000	0.1000
A2	0.0314	0.0354	0.8000	0.9000
b	0.0098	0.0157	0.2500	0.4000
c	0.0031	0.0059	0.0800	0.1500
D	0.0472	0.0551	1.2000	1.4000
E	0.0629	0.0709	1.6000	1.8000
E1	0.0984	0.1063	2.5000	2.7000
L	0.0187TYP		0.475TYP	
L1	0.0098	0.0157	0.250	0.400
θ	0°	8°	0°	8°

- Note:
- All dimensions are in millimeters (mm) unless otherwise specified.  
[所有尺寸均以毫米为单位，除非另有说明]
  - General tolerances:  $\pm 0.10\text{mm}$  unless otherwise specified.  
[通用公差为 $\pm 0.10\text{mm}$ ，除非另有说明]
  - Dimensions and tolerances per ASME Y14.5M-2018.  
[尺寸和公差遵循 ASME Y14.5M-2018 标准]
  - All dimensions shown are exclusive of burrs and gate residues.  
Burrs and gate vestiges shall not exceed 0.15 mm in maximum.  
[所有尺寸均不包括毛刺和浇口残留，毛刺与浇口残留的尺寸最大不得超过 0.15mm]
  - Dimension b does not include dambar protrusion of max 0.100 mm per side.  
[尺寸b不包括单边最大0.100 MM的中筋凸出部分]
  - Dimensions D and E are the overall extreme outer dimensions of the mold compound. These dimensions exclude mold flash, lead flash, protrusions and burrs but include the maximum allowable mold mismatch.  
[D和E是塑封体的外部极限尺寸，不包括包封溢料、内引线溢料、凸出部分以及胶体毛刺，但是包含了包封错位的最大尺寸]
  - Formed leads shall be planar with respect to one another within a maximum of 0.076 mm relative to the seating plane.  
[成型的管脚应为同一平面，共面性最大为0.1mm]

## ■ Suggested Pad Layout





## B5817WS THRU B5819WS

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